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HALOGEN FREE

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Vishay Semiconductors

High Power Infrared Emitting Diode, 940 nm, Surface Emitter Technology



LINKS TO ADDITIONAL RESOURCES



DESCRIPTION

As part of the <u>SurfLightTM</u> portfolio, the VSMA1094400 is an infrared, 940 nm emitting diode. It features a double stack emitter chip for highest radiant power. The 42 mil chip size allows 1.5 A DC operation and supports pulsed currents up to 5.0 A.

FEATURES

- Package type: surface-mount
- · Package form: high power SMD with lens
- Dimensions (L x W x H in mm): 3.4 x 3.4 x 2.45
- Centroid wavelength: λ_{centroid} = 940 nm
- Angle of half intensity: $\varphi = \pm 40^{\circ}$
- Designed for high drive currents: up to 1.5 A (DC) and up to 5 A (pulsed)
- Low thermal resistance: 6 K/W < R_{thJSP} < 9 K/W
- ESD: up to 5 kV (according to ANSI / ESDA / JEDEC® JS-001)
- Floor life: 168 h, MSL 3, according to J-STD-020
- · Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Driver and occupant monitoring
- Eve tracking
- · Safety and security, CCTV

PRODUCT SUMMARY					
COMPONENT	I_e (mW/sr) at I_F = 1.0 A	φ (°)	$\lambda_{\mathbf{p}}$ (nm)	$\lambda_{centroid}$ (nm)	t _r (ns)
VSMA1094400	850	± 40	950	940	10

Note

• Test conditions see table "Basic Characteristics"

ORDERING INFORMATION						
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM			
VSMA1094400	Tape and reel	MOQ: 600 pcs, 600 pcs/reel	High power with lens			

Note

• MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V_R	5	V	
Forward current		l _F	1.5	Α	
Surge forward current	t _p = 100 μs	I _{FSM}	5	Α	
Power dissipation		P_V	5	W	
Junction temperature		Tj	145	°C	
Ambient temperature range		T _{amb}	-40 to +125	°C	
Storage temperature range		T_{stg}	-40 to +125	ç	
Soldering temperature	According to Fig. 11, J-STD020E	T_{sd}	260	ç	
Thermal resistance junction to solder point real (1)	JESD 51	R _{thJSP,real}	6 to 9	K/W	
Thermal resistance junction to ambient real	JESD 51	R _{thJA,real}	150	K/W	
ESD sensitivity	According to ANSI / ESDA / JEDEC JS-001	V _{ESD}	5	kV	

Note

⁽¹⁾ Thermal resistance junction to solder point real has been measured with the part mounted on an ideal heatsink and the optical output power has been deducted from the total electrical power dissipation

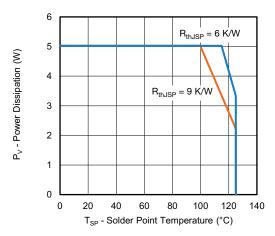


Fig. 1 - Power Dissipation Limit vs. Solder Point Temperature

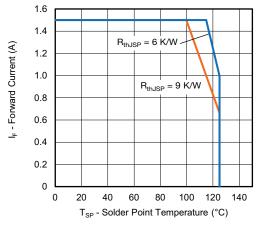


Fig. 2 - Forward Current Limit vs. Solder Point Temperature



PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 0.35 \text{ A}, t_p = 10 \text{ ms}$	V _F	2.4	2.8	3.0	V
	$I_F = 1 \text{ A}, t_p = 100 \ \mu\text{s}$	V _F	2.5	2.95	3.1	V
	$I_F = 1.5 \text{ A}, t_p = 100 \mu \text{s}$	V _F	2.6	3.05	3.35	V
	$I_F = 5 \text{ A}, t_p = 100 \ \mu\text{s}$	V _F	2.9	3.7	4.2	V
Temperature coefficient of V _F	$I_F = 1 A, t_p = 200 \mu s$		-	-2	-	mV/K
Reverse current		I _R	Not designed for reverse operation μA			μA
Radiant intensity	$I_F = 0.35 \text{ A}, t_p = 10 \text{ ms}$	l _e	250	325	400	mW/sr
	$I_F = 1 \text{ A}, t_p = 100 \mu \text{s}$	l _e	625	850	1075	mW/sr
	$I_F = 1.5 \text{ A}, t_p = 100 \mu \text{s}$	l _e	875	1225	1575	mW/sr
	$I_F = 5 \text{ A}, t_p = 100 \ \mu\text{s}$	l _e	2500	3600	4750	mW/sr
Radiant power	$I_F = 1 A, t_p = 100 \mu s$	фe	-	1425	-	mW
	$I_F = 1.5 \text{ A}, t_p = 100 \mu \text{s}$	фe	-	2100	-	mW
Temperature coefficient of φ	$I_F = 1 A, t_p = 200 \mu s$	TΚ _φ	-	-0.15	-	%/K
Angle of half intensity		φ	-	± 40	-	۰
Peak wavelength	$I_F = 1 \text{ A}, t_p = 300 \ \mu\text{s}$	λρ	-	950	-	nm
Centroid wavelength	$I_F = 1 A, t_p = 300 \mu s$	λ _{centroid}	-	940	-	nm
Spectral bandwidth	$I_F = 1 A, t_p = 300 \mu s$	Δλ	-	42	-	nm
Temperature coefficient of λ_p	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	TK _{λp}	-	0.3	-	nm/K
Rise time	I _F = 1 A	t _r	-	10	-	ns
Fall time	I _F = 1 A	t _f	-	15	-	ns

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

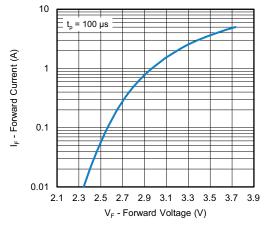


Fig. 3 - Relative Radiant Intensity vs. Forward Current

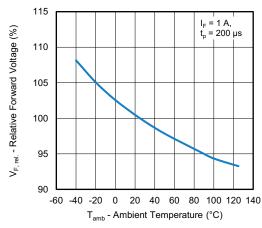


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

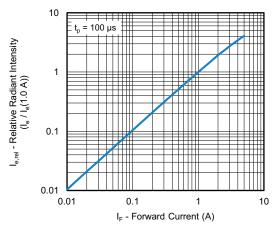


Fig. 5 - Relative Radiant Intensity vs. Forward Current

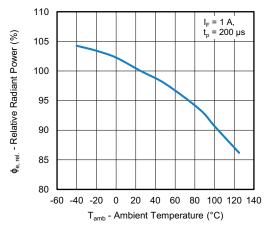


Fig. 6 - Relative Radiant Power vs. Ambient Temperature

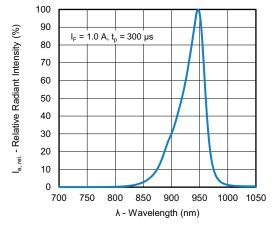


Fig. 7 - Relative Radiant Intensity vs. Wavelength

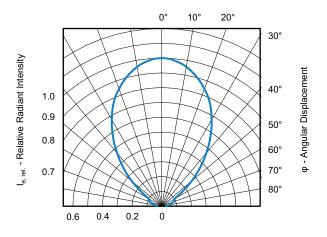


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

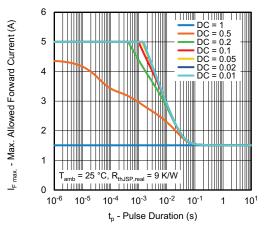


Fig. 9 - Max. Allowed Forward Current vs. Pulse Duration

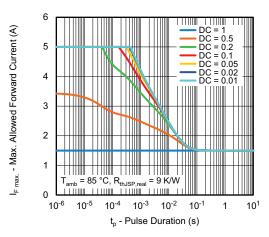
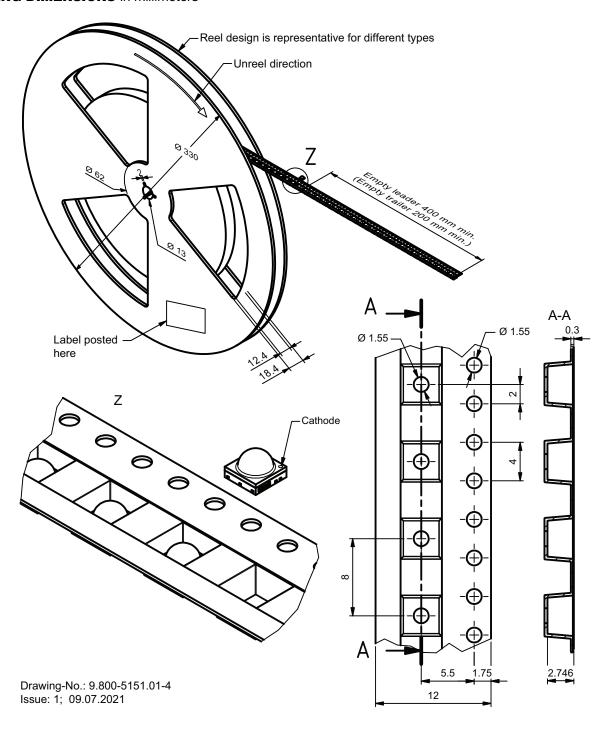


Fig. 10 - Max. Allowed Forward Current vs. Pulse Duration



TAPING DIMENSIONS in millimeters

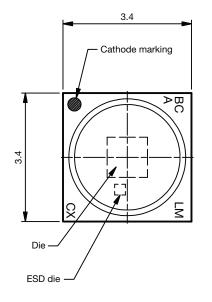


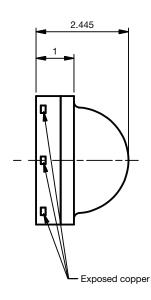
Notes

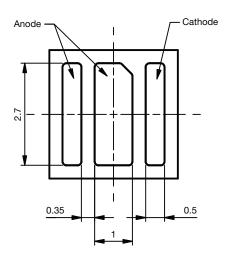
- Empty component pockets sealed with top cover tape
- 7 inch reel 600 pieces per reel
- The maximum number of consecutive missing lamps is two
- In accordance with ANSI / EIA 481-1-A-1994 specifications



PACKAGE DIMENSIONS in millimeters

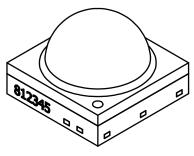


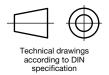




Not indicated tolerances \pm 0.1

Drawing-No.: 6.550-5367.01-4 Issue: 1; 09.07.2021



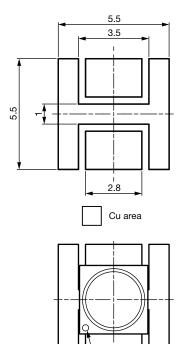


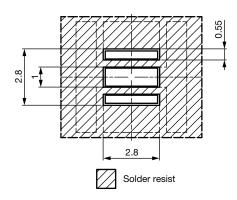
Notes

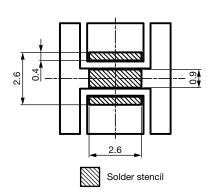
- Tolerance is ± 0.10 mm (0.004") unless otherwise noted
- Specifications are subject to change without notice



RECOMMENDED FOOTPRINT

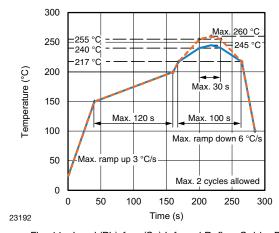






Drawing-No.: 6.550-5366.9-3 Issue: 1; 09.07.2021

SOLDER PROFILE



Cathode marking

Component location on pad

Fig. 11 - Lead (Pb)-free (Sn) Infrared Reflow Solder Profile According to J-STD020E for Surface-Mount Components

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 3, according to J-STD-020B

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-033D or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 $^{\circ}$ M.



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Vishay

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